

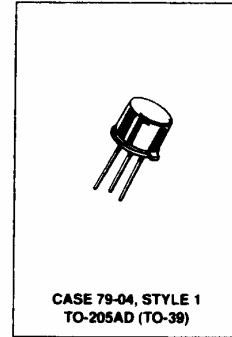
2N4405

PNP Silicon  
Small-Signal Transistor

...designed for general-purpose switching and amplifier applications.

CRYSTALONCS  
2805 Veterans Highway  
Suite 14  
Ronkonkoma, N.Y. 11779

MAXIMUM RATINGS			
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	80	Vdc
Collector-Base Voltage	V <sub>CB0</sub>	80	Vdc
Emitter-Base Voltage	V <sub>EB0</sub>	5.0	Vdc
Collector Current — Continuous	I <sub>C</sub>	0.5	Adc
Device Dissipation	P <sub>T</sub>		
@ T <sub>A</sub> @ 25°C		1.0	Watts
Derate above 25°C		5.72	mW/°C
@ T <sub>C</sub> @ 25°C		5.0	Watts
Derate above 25°C		28.6	mW/°C
Operating Junction and Storage Temperature Range	T <sub>op</sub> , T <sub>stg</sub>	-65 to 200	°C



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25°C unless otherwise noted.)				
Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Breakdown Voltage <sup>(1)</sup> (I <sub>C</sub> = 10 mA <sub>dc</sub> , I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	80	—	Vdc
Collector-Base Breakdown Voltage (I <sub>C</sub> = 10 μA <sub>dc</sub> , I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	80	—	Vdc
Emitter-Base Breakdown Voltage (I <sub>E</sub> = 10 μA <sub>dc</sub> )	V <sub>(BR)EBO</sub>	5.0	—	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 60 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	—	25	nAdc
(V <sub>CB</sub> = 60 Vdc, I <sub>E</sub> = 0, T <sub>A</sub> = 150°C)		—	25	μAdc
Emitter-Cutoff Current (V <sub>BE</sub> = 3.0 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	—	25	nAdc

(1) Pulsed Pulse Width 250 to 350 μs, Duty Cycle 1.0 to 2.0%

(continued)

2N4405JAN SEIRES

ELECTRICAL CHARACTERISTICS — continued (T <sub>A</sub> = 25°C unless otherwise noted.)				
Characteristic	Symbol	Min	Max	Unit
<b>ON CHARACTERISTICS</b>				
DC Current Gain <sup>(1)</sup> (I <sub>C</sub> = 0.1 mA, V <sub>CE</sub> = 5.0 Vdc) (I <sub>C</sub> = 10 mA, V <sub>CE</sub> = 5.0 Vdc) (I <sub>C</sub> = 150 mA, V <sub>CE</sub> = 5.0 Vdc) (I <sub>C</sub> = 500 mA, V <sub>CE</sub> = 5.0 Vdc) (I <sub>C</sub> = 150 mA, V <sub>CE</sub> = 5.0 Vdc, T <sub>A</sub> = -65 ± 3°C)	h <sub>FE</sub>	75 100 100 50 40	— — 300 — —	—
Collector-Emitter Saturation Voltage <sup>(1)</sup> (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1.0 mA) (I <sub>C</sub> = 150 mA, I <sub>B</sub> = 15 mA) (I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA)	V <sub>CE(sat)</sub>	— — —	0.15 0.2 0.5	Vdc
Base-Emitter Saturation Voltage <sup>(1)</sup> (I <sub>C</sub> = 10 mA, I <sub>B</sub> = 1.0 mA) (I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA)	V <sub>BE(sat)</sub>	— 0.85	0.8 1.2	Vdc
Base-Emitter On-Voltage (I <sub>C</sub> = 150 mA, V <sub>CE</sub> = 5.0 Vdc)	V <sub>BE</sub>	—	0.9	Vdc
<b>SMALL-SIGNAL CHARACTERISTICS</b>				
Collector-Base Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 0.1 to 1.0 MHz)	C <sub>obo</sub>	—	10	pF
Small-Signal Current Transfer Ratio, Magnitude (I <sub>C</sub> = 50 mA, V <sub>CE</sub> = 20 Vdc, f = 100 MHz)	h <sub>fe</sub>	2.0	6.0	—
Noise Figure (I <sub>C</sub> = 1.0 mA, V <sub>CE</sub> = 10 Vdc, f = 1.0 kHz, R <sub>s</sub> = 100 ohms)	NF	—	3.5	dB
<b>SWITCHING CHARACTERISTICS</b> (See Figure 33) (I <sub>C</sub> = 500 mA, V <sub>BE(off)</sub> = 0.8 Vdc, I <sub>B</sub> = 50 mA)				
Delay Time	t <sub>d</sub>	—	15	ns
Rise Time	t <sub>r</sub>	—	25	ns
Storage Time	t <sub>s</sub>	—	175	ns
Fall Time	t <sub>f</sub>	—	50	ns

**ASSURANCE TESTING (Pre/Post Burn-In)**  
**Burn-In Conditions: T<sub>A</sub> = 25 ± 3°C, V<sub>CB</sub> = 40 Vdc**  
**P<sub>T</sub> = 1.0 W**

Characteristics Tested	Symbol	Initial and End Point Limits		Unit
		Min	Max	
Collector Cutoff Current (V <sub>CB</sub> = 60 Vdc)	I <sub>CBO</sub>	—	25	nAdc
DC Current Gain <sup>(1)</sup> (I <sub>C</sub> = 10 mA, V <sub>CE</sub> = 5.0 Vdc)	h <sub>FE</sub>	100	—	—
<b>Delta from Pre-Burn-In Measured Values</b>				
Delta Collector Cutoff Current	ΔI <sub>CBO</sub>	—	+100 or ±10 whichever is greater	% of Initial Value nAdc
Delta DC Current Gain <sup>(1)</sup>	Δh <sub>FE</sub>	—	±20	%

<sup>(1)</sup> Pulsed. Pulse Width 250 to 350 μs. Duty Cycle 1:0 to 2:0.